

Single P-channel MOSFET

ELM321604A-S

■General description

ELM321604A-S uses advanced trench technology to provide excellent $R_{ds(on)}$, low gate charge and low gate resistance.

■Features

- $V_{ds} = -40V$
- $I_d = -43A$
- $R_{ds(on)} < 16m\Omega$ ($V_{gs} = -10V$)
- $R_{ds(on)} < 20m\Omega$ ($V_{gs} = -7V$)

■Maximum absolute ratings

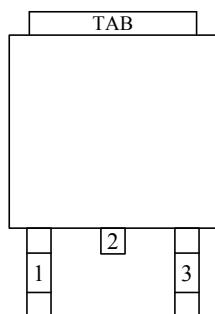
Parameter	Symbol	Limit	Unit	Note
Drain-source voltage	V_{ds}	-40	V	
Gate-source voltage	V_{gs}	± 20	V	
Continuous drain current	I_d	-43	A	
Ta=70°C		-34		
Pulsed drain current	I_{dm}	-130	A	3
Avalanche current	I_{as}	-40.8	A	
Avalanche energy	E_{as}	83	mJ	
Power dissipation	P_d	50	W	
Ta=70°C		32		
Junction and storage temperature range	T_j, T_{stg}	-55 to 150	°C	

■Thermal characteristics

Parameter	Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-case	$R_{\theta jc}$		2.5	°C/W	
Maximum junction-to-ambient	$R_{\theta ja}$		75.0	°C/W	

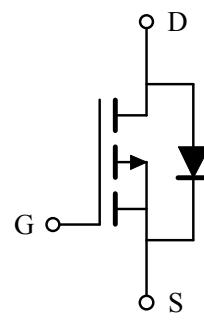
■Pin configuration

TO-252-3(TOP VIEW)



Pin No.	Pin name
1	GATE
2	DRAIN
3	SOURCE

■Circuit



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■Electrical characteristics

T_a=25°C

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit	Note
STATIC PARAMETERS							
Drain-source breakdown voltage	BV _{dss}	I _d =-250μA, V _{gs} =0V	-40			V	
Zero gate voltage drain current	Id _s	V _{ds} =-32V, V _{gs} =0V			-1	μA	
		V _{ds} =-30V, V _{gs} =0V T _j =125°C			-10		
Gate-body leakage current	I _{gss}	V _{ds} =0V, V _{gs} =±20V			±100	nA	
Gate threshold voltage	V _{gs(th)}	V _{ds} =V _{gs} , I _d =-250μA	-1.5	-2.2	-3.0	V	
On state drain current	I _{d(on)}	V _{ds} =-5V, V _{gs} =-10V	-130			A	1
Static drain-source on-resistance	R _{d(on)}	V _{gs} =-10V, I _d =-25A		13	16	mΩ	1
		V _{gs} =-7V, I _d =-15A		16	20	mΩ	
Forward transconductance	G _{fs}	V _{ds} =-5V, I _d =-25A		24		S	1
Diode forward voltage	V _{sd}	I _f =-25A, V _{gs} =0V			-1.3	V	1
Max. body-diode continuous current	I _s				-43	A	
DYNAMIC PARAMETERS							
Input capacitance	C _{iss}	V _{gs} =0V, V _{ds} =-15V f=1MHz		2350		pF	
Output capacitance	C _{oss}			480		pF	
Reverse transfer capacitance	C _{rss}			310		pF	
Gate resistance	R _g	V _{gs} =0V, V _{ds} =0V, f=1MHz		4.3		Ω	
SWITCHING PARAMETERS							
Total gate charge	Q _g	V _{gs} =-10V, V _{ds} =-20V I _d =-25A		42		nC	2
Gate-source charge	Q _{gs}			9		nC	2
Gate-drain charge	Q _{gd}			10		nC	2
Turn-on delay time	t _{d(on)}	V _{gs} =-10V, V _{ds} =-20V I _d =-1A, R _{gen} =6Ω		15		ns	2
Turn-on rise time	t _r			43		ns	2
Turn-off delay time	t _{d(off)}			62		ns	2
Turn-off fall time	t _f			50		ns	2
Body diode reverse recovery time	t _{rr}	I _f =-20A, dI _f /dt=100A/μs		43		ns	
Body diode reverse recovery charge	Q _{rr}			31		nC	

NOTE :

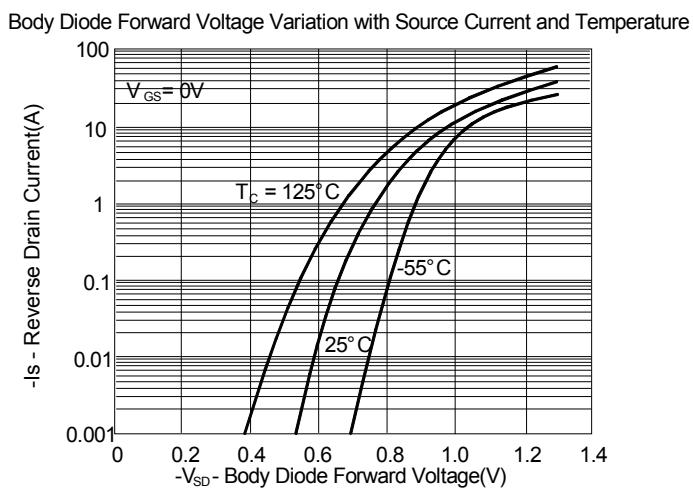
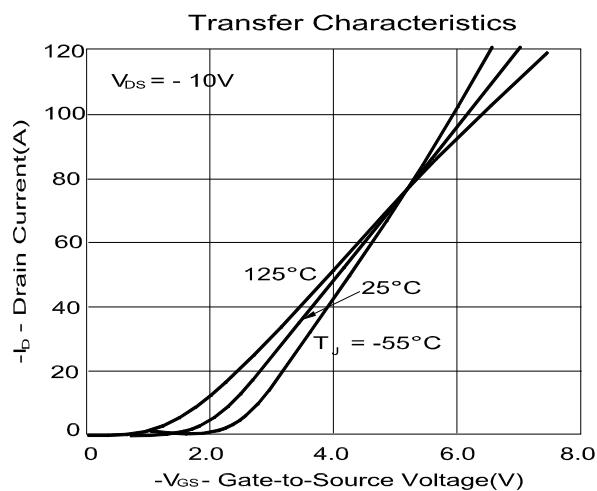
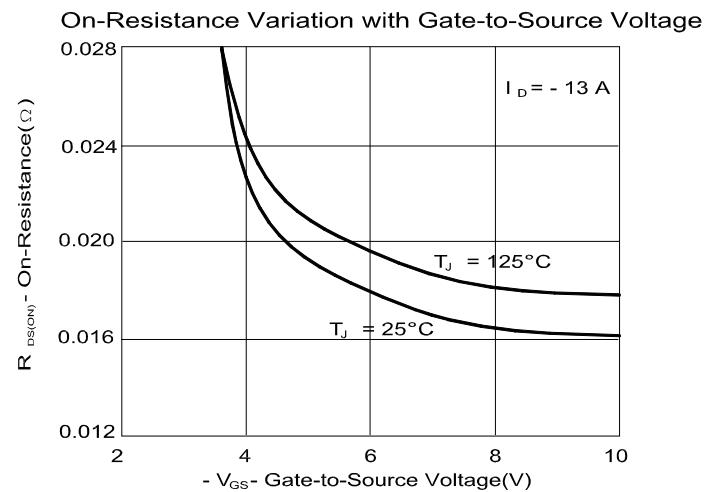
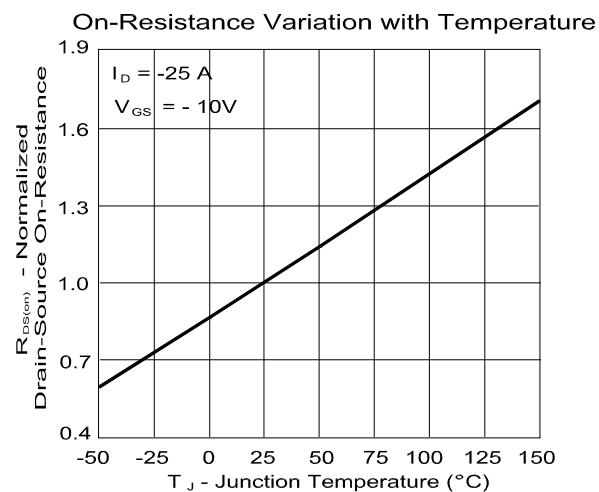
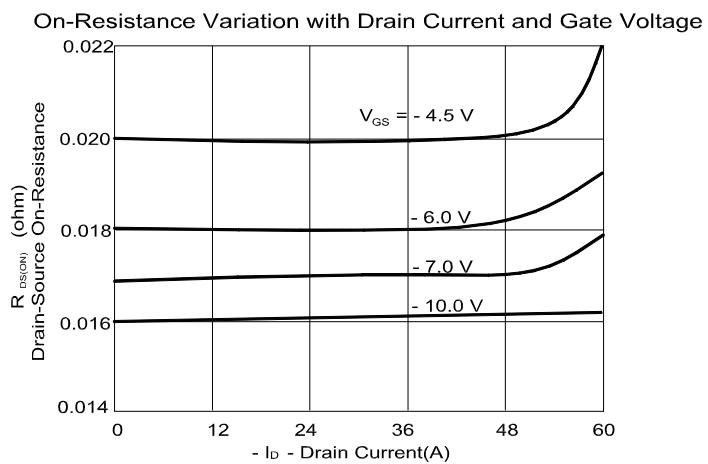
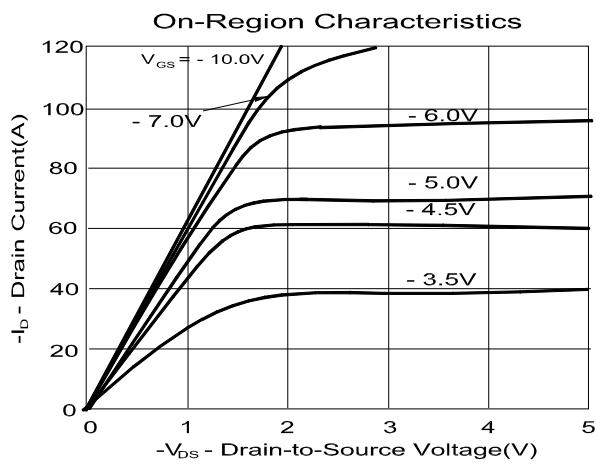
1. Pulse test : Pulsed width ≤ 300μsec and Duty cycle ≤ 2%.
2. Independent of operating temperature.
3. Pulsed width limited by maximum junction temperature.



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■ Typical electrical and thermal characteristics



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